8-bit 20 MSPS RGB 3-Channel D/A Converter

Description

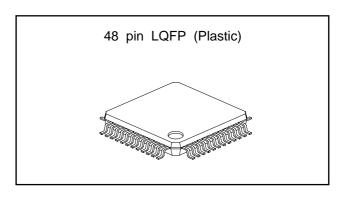
The CXD2304R is an 8-bit high-speed D/A converter for video band use. It has an input/output equivalent to 3 channels of R, G and B. It is suitable for use of digital TV, graphic display, and others.

Features

- Resolution 8-bit
- Maximum conversion speed 20 MSPS
- RGB 3-channel input/output
- Differential linearity error ±0.5 LSB
- Low power consumption 50 mW (330 Ω load at 1.2 Vp-p output)
- Single 3.3 V power supply
- · Low glitch noise
- Stand-by function

Structure

Silicon gate CMOS IC



Absolute Maximum Ratings (Ta=25 °C)

- Supply voltage AVDD, DVDD 7
- Input voltage (All pins)

VIN VDD+0.5 to Vss-0.5 V

Output current (Every each channel)

IOUT 0 to 15 mA

• Storage temperature Tstg -55 to +150 °C

Recommended Operating Conditions

• Supply voltage AVDD, AVss 3.0 to 3.6 V

DV_{DD}, DVss 3.0 to 3.6

• Reference input voltage

VREF 1.2 V

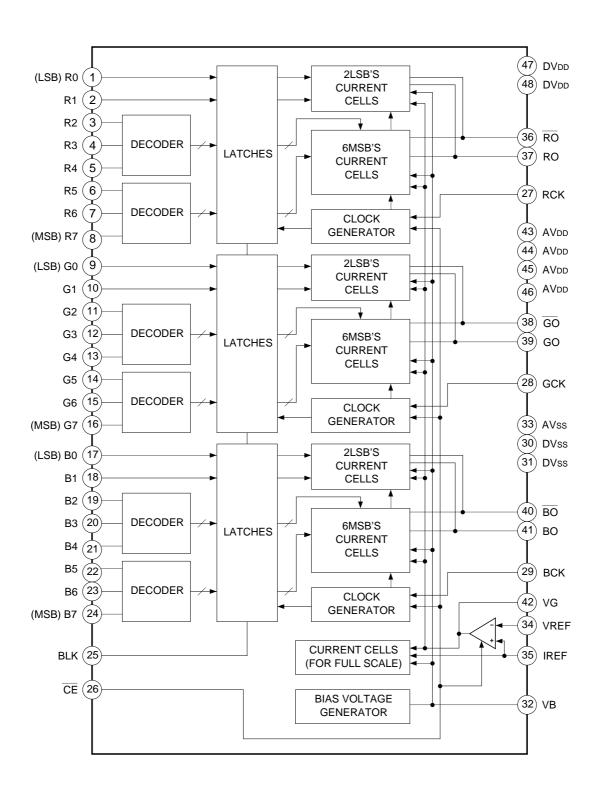
Clock pulse width

TPW1, TPW0 22.5 ns (min.) to 1.1 µs (max.)

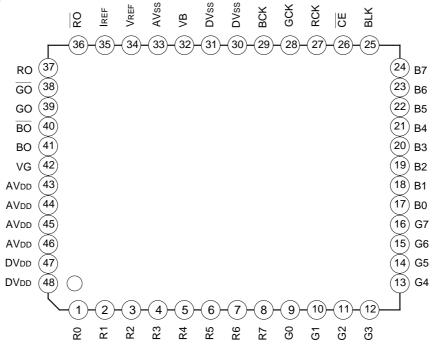
Operating temperature

Topr -40 to +85 °C

Block Diagram



Pin Configuration



Pin Description and I/O Pins Equivalent Circuit

Pin No.	Symbol	I/O	Equivalent circuit	Description		
1 to 8	R0 to R7		→ DV _{DD}	Digital input		
9 to 16	G0 to G7	l	1 to W—	R0 (LSB) to R7 (MSB) G0 (LSB) to G7 (MSB) B0 (LSB) to B7 (MSB)		
17 to 24	B0 to B7		DVss	DO (LOD) TO D7 (MOD)		
25	BLK	I	DVDD W DVss	Blanking input. This is synchronized with the clock input signal for each channel. No signal at "H" (Output 0 V). Output condition at "L".		
32	VB	Ō	DVDD O DV	Connect a capacitor of about 0.1 µF.		

Pin No.	Symbol	I/O	Equivalent circuit	Description
27	RCK		o DVdd	
28	GCK	l	27	Clock input.
29	вск		DVss	
30, 31	DVss	_		Digital GND
33	AVss	_		Analog GND
26	CE	I	DVDD W DVss	Chip enable input. This is not synchronized with the clock input signal. No signal (Output 0 V) at "H" and minimizes power consumption.
35	IREF	ō	AVDD O AVDD	Reference current output. Connect a resistance 16 times "Rir" that of output resistance value "Rout".
34	VREF	I	AVDD AVSS AVDD AVSS AVDD	Reference voltage output. Set full scale output value.
42	VG	ō	AVss	Connect a capacitor of about 0.1 µF.
43 to 46	AVdd	_		Analog VDD

Pin No.	Symbol	I/O	Equivalent circuit	Description
37	RO			
39	GO		AVDD O	Current output. Voltage output can be obtained by connecting a resistance.
41	во	0	39 41 AVss	
36	RO		AVDD 0 36 38	
38	GO		AVss AVss	Inverted current output. Normally dropped to analog GND.
40	ВО			
47, 48	DVdd	_		Digital V _{DD}

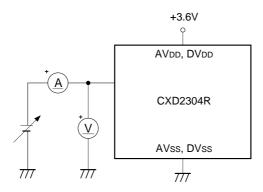
Electrical Characteristics (Fclk=20 MHz, AVdd=DVdd=3.3 V, Rout=330 Ω , Vref=1.2 V, Rir=5.1 k Ω , Ta=25 °C)

Item	Symbol	Measurement con-	ditions	Min.	Тур.	Max.	Unit	
Resolution	n				8		bit	
Conversion speed	Conversion speed FCLK AVDD=DVDD=3.0 to 3.6 V Ta=-40 to 85 °C		0.5		20	MSPS		
Integral non-linearity error	EL	Fadaciat		-2.5		2.5	LSB	
Differential non-linearity error	Ed	Endpoint		-0.5		0.5	LSB	
Output full-scale voltage	VFS			1.12	1.24	1.36	V	
Output full-scale ratio *1	Fsr			0	1.5	3.0	%	
Output full-scale current	IFS				3.8		mA	
Output offset voltage	Vos	When "00000000" data	a input			1	mV	
Glitch energy	GE				150		pV•s	
Crosstalk	CT	When 1 kHz sine wave	e input		53		dB	
Supply current	IDD	When 14.3 MHz color	CE= "L"		15	18	mA	
Зарріу сапені	Іѕтв	bar data input	CE= "H"			1.2	1 MA	
Analog input resistance	Rin	VREF		1			MΩ	
Input capacitance	Сі					9	pF	
Digital input voltage	Vін	AVDD=DVDD=3.0 to 3.6	6 V	2.5			V	
Digital input voltage	VIL	Ta=-20 to +75 °C				0.5	V	
Digital input ourrent	Іін	AVDD=DVDD=3.0 to 3.6	6 V	-5		5 µ		
Digital input current	lıL	Ta=-20 to +75 °C		-5			μA	
Setup time	ts			7			ns	
Hold time	th			3			ns	
Propagation delay time	t PD				20		ns	
CE enable time *2	tE	CE =H→L			4	8	ms	
CE disable time *2	to	CE =L→H			4	8	ms	

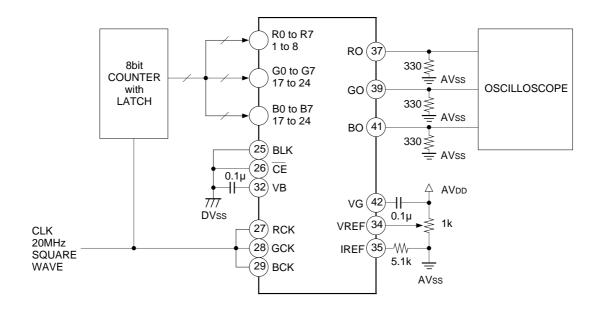
*1	Full-scale output ratio =	Full-scale voltage of channel		× 100 (%)
•	Full-scale output fatto =	Average of the full-scale voltage of the channels	-,	× 100 (78)

^{*2} When the external capacitors for the VG pins are 0.1 µF.

Electrical Characteristics Measurement Circuit Analog Input Resistance Digital Input Current Measurement Circuit

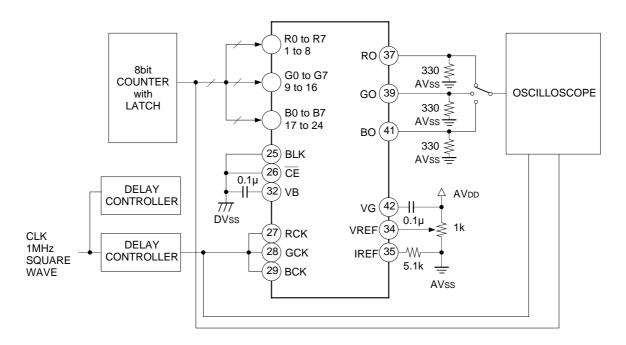


Maximum Conversion Velocity Measurement Circuit

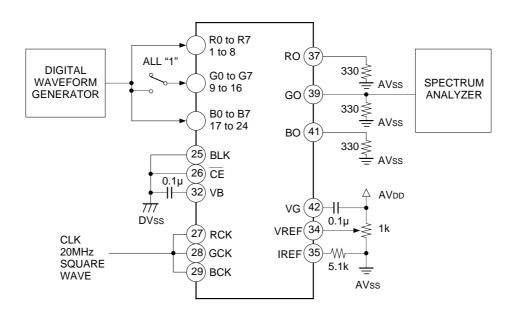


Setup Time
Hold Time
Glitch Energy

Measurement Circuit

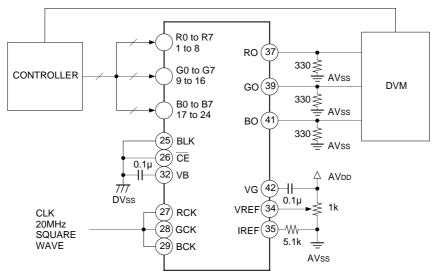


Crosstalk Measurement Circuit

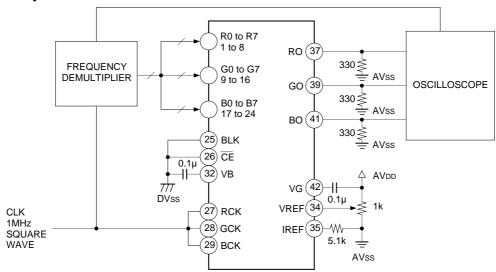


SONY CXD2304R

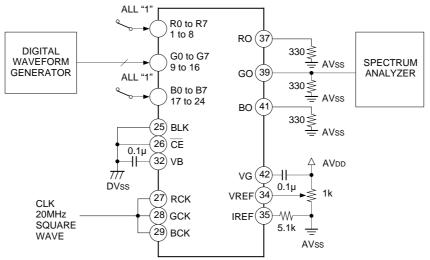
DC Characteristics Measurement Circuit



Propagation Delay Time Measurement Circuit



SNR Measurement Circuit

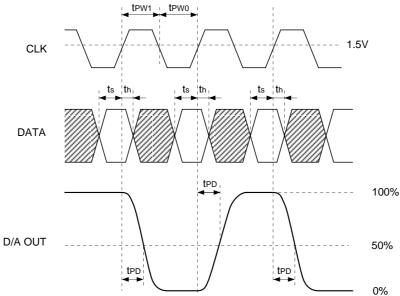


SNR: Different between primary

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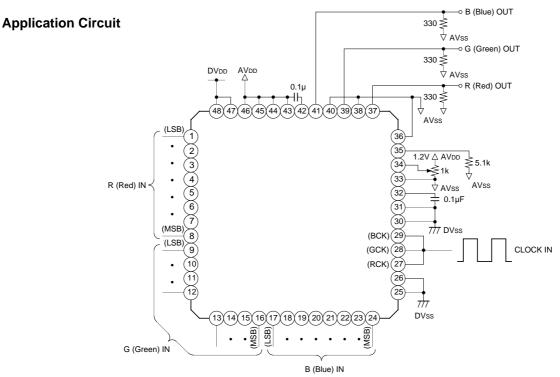
component and secondary distortion

Description of Operation Timing Chart



I/O Chart (when full scale output voltage at 1.2 V)

Input co	Output voltage	
MSB	LSB	
11111	1 1 1	1.2 V
: 10000 :	0 0 0	0.6 V
00000	0 0 0	0 V



Application circuits shown are typical examples illustrating the operation of the devices. Sony cannot assume responsibility for any problems arising out of the use of these circuits or for any infringement of third party patent and other right due to same.

Notes on Operation

• How to select the output resistance

The CXD2304R is a D/A converter of the current output type. To obtain the output voltage connect the resistance to the current output pins R0, G0 and B0. For specifications we have;

Output full scale voltage VFs=1.12 to 1.36 [V]

Output full scale current IFS=3.8 [mA] (typ.)

Calculate the output resistance value from the relation of VFs=IFs \times Rout. Also, 16 times resistance of the output resistance Rout is connected to reference current pin IREF. In some cases, however, this turns out to be a value that does not actually exist. In such a case a value close to it can be used as a substitute.

Here please note that VFS becomes

 $V_{FS}=V_{REF}\times 16R_{OUT}/R_{IR}$.

VREF is the voltage set at the reference voltage pin VREF and Rout is the resistance connected to the current output pins RO, GO and BO while RIR is connected to IREF pin.

Increasing the resistance value can curb power consumption. On the other hand glitch energy and data settling time will inversely increase. Set the most suitable value according to the desired application.

Phase relation between data and clock

To obtain the expected performance as a D/A converter, it is necessary to set properly the phase relation between data and clock applied from the exterior. Be sure to satisfy the provisions of the setup time (ts) and hold time (th) as stipulated in the Electrical Characteristics.

Power supply and ground

To reduce noise effects separate analog and digital systems in the device periphery. For power supply pins, both digital and analog, bypass respective grounds by using a ceramic capacitor of about 0.1 μ F, as close as possible to the pin.

Latch up

Digital power supply and analog power supply have to be common at the PCB power supply source. This is to prevent latch up due to voltage difference between AVDD and DVDD pins when power supply is turned ON.

• RO, GO and BO pins

The RO, GO and BO pins are the inverted current output pins described in the Pin Description. The sums shown below become the constant value for any input data.

- a) The sum of the currents output form RO and RO
- b) The sum of the currents output form GO and $\overline{\text{GO}}$
- c) The sum of the currents output form BO and BO

However, the performances such as the linearity error of the inverted current output pin output current is not guaranteed.

Output full-scale voltage

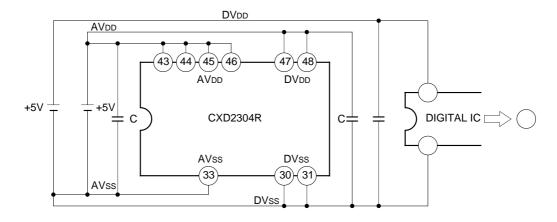
For the applications using the RGB signal, the color balance may be broken up when the no-adjusted output full-scale voltage is used.

Latch Up Prevention

The CXD2304R is a CMOS IC which required latch up precautions. Latch up is mainly generated by the lag in the voltage rising time of AVDD (Pins 43 to 46) and DVDD (Pins 47 and 48), when power supply is ON.

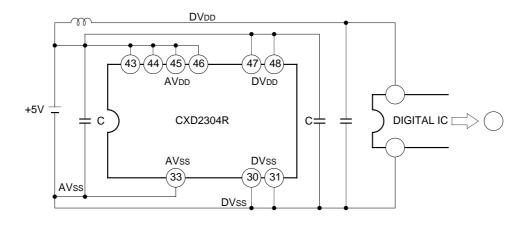
1. Correct usage

a. When analog and digital supplies are from different sources

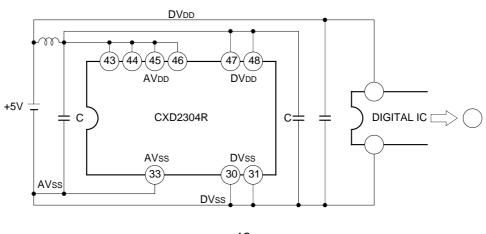


b. When analog and digital supplies are from a common source

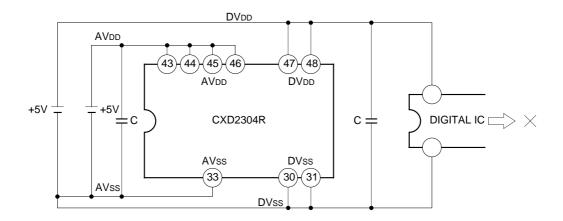
(i)



(ii)

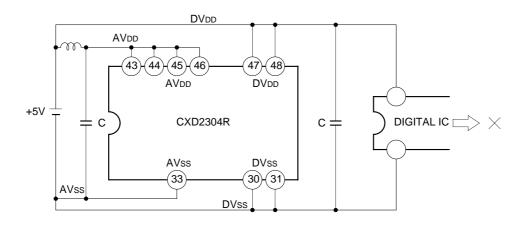


- 2. Example when latch up easily occurs
- a. When analog and digital supplies are from different sources

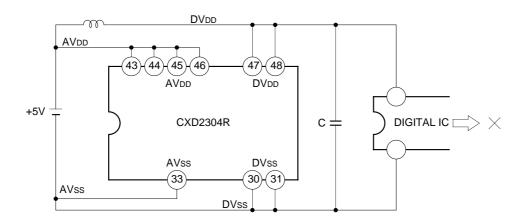


b. When analog and digital supplies are from common source

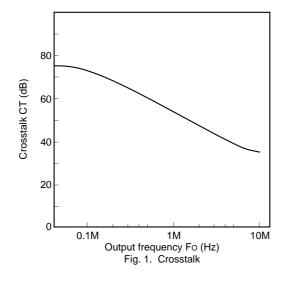
(i)

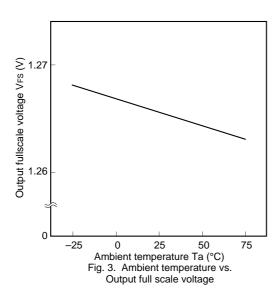


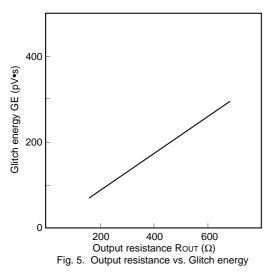
(ii)

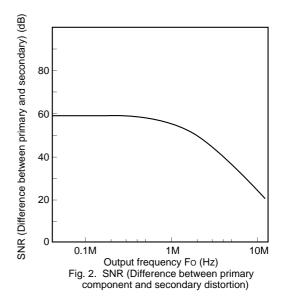


Example of Representative Characteristics









Power supply current lbb (mA)

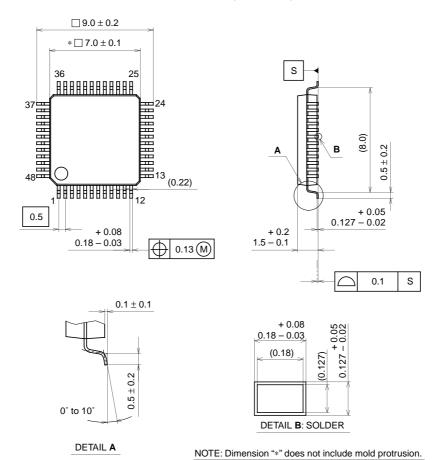
Reference measurement condition and description

Output frequency Fo (Hz)
Fig. 4. Output frequency vs.
Power supply current

- AVDD=3.3 V
- DVDD=3.3 V
- VREF=1.2 V
- RIR=5.1 k Ω (\approx 16 ROUT in Fig. 5 only)
- Ta=25 °C (Except Fig. 3)
- Fig. 1, 2 Refer to the measurement circuit.
- Fig. 3 is input data=all 1
- Fig. 4 is input data=output of incremental counter.

Package Outline Unit: mm

48PIN LQFP (PLASTIC)



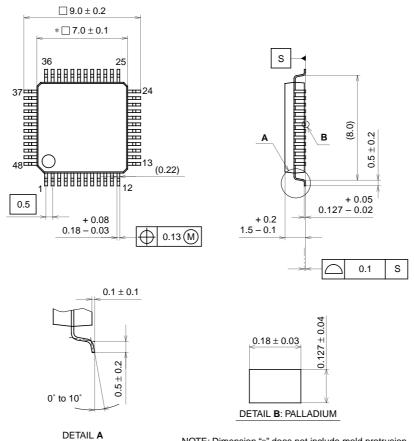
PACKAGE STRUCTURE

SONY CODE	LQFP-48P-L01
EIAJ CODE	P-LQFP48-7x7-0.5
JEDEC CODE	

PACKAGE MATERIAL	EPOXY RESIN
LEAD TREATMENT	SOLDER PLATING
LEAD MATERIAL	42/COPPER ALLOY
PACKAGE MASS	0.2g

Package Outline Unit: mm

48PIN LQFP (PLASTIC)



NOTE: Dimension " \ast " does not include mold protrusion.

SONY CODE LQFP-48P-L01 EIAJ CODE P-LQFP48-7x7-0.5 JEDEC CODE

PACKAGE STRUCTURE				
PACKAGE MATERIAL	EPOXY RESIN			
LEAD TREATMENT	PALLADIUM PLATING			
LEAD MATERIAL	COPPER ALLOY			
PACKAGE MASS	0.2g			